

I.I.T

INDIAN INSTITUTE OF TECHNOLOGY KANPUR KALYANPUR, KANPUR-U.P.

208016

TENDER REFERENCE NO. : IITK/PHY/IMPII/2019-20/01
BID SUBMISSION END DATE- 16.09.2019

TENDER DOCUMENTS

FOR

"Purchase of Manual Wedge wire and Ribbon Bonder"

BID DOCUMENT

Online bids (Technical & Financial) from eligible bidders which are valid for a period of 120 days from the date of Technical Bid opening (i.e. 17.09.2019) are invited for and on behalf of the Assistant Registrar, IIT Kanpur for "**Purchase of Manual Wedge wire and Ribbon Bonder**".

Name of Work	Purchase of Manual Wedge wire and Ribbon Bonder
Estimated Cost	Rs.15,00,000/-
Date of Publishing	27.08.2019 (17:00 hrs)
Clarification Start Date and Time	27.08.2019 (17:00 hrs)
Clarification End Date and Time	16.09.2019 (16:00 hrs)
Queries (if any)	No queries will be entertained after clarification end date and time
Bid Submission Start Date	27.08.2019 (17:00 hrs
Last Date and time of uploading of Bids	16.09.2019 (16.00 hrs)
Last Date and time of submitting , EMD and other documents at IIT Kanpur (if any)	NA
Date and time of opening of Technical Bids	17.09.2019 (16:00 hrs)
Date and time of opening of Financial Bids	Will be separately notified for Technically shortlisted/qualified bidders

Interested parties may view and download the tender document containing the detailed terms & conditions from the website http://eprocure.gov.in/eprocure/app

(The bids have to be submitted online in electronic form on www.eprocure.gov.in only. No physical bids will be accepted.)

INSTRUCTION FOR ONLINE BID SUBMISSION

The bidders are required to submit soft copies of their bids electronically on the Central Public Procurement (CPP) Portal iehttp://eprocure.gov.in/eprocure/app, using valid Digital Signature Certificates. The instructions given below are meant to assist the bidders in registering on the CPP Portal, prepare their bids in accordance with the requirements and submitting their bids online on the CPP Portal.

REGISTRATION

- (i) Bidders are required to enroll on the e-Procurement module of the Central Public Procurement Portal (URL: https://eprocure.gov.in/eprocure/app) by clicking on the link "Online Bidder Enrolment" option available on the home page. Enrolment on the CPP Portal is free of charge.
- (ii) During enrolment/ registration, the bidders should provide the correct/ true information including valid email-id & mobile no. All the correspondence shall be made directly with the contractors/ bidders through email-id provided.
- (iii) As part of the enrolment process, the bidders will be required to choose a unique username and assign a password for their accounts.
- (iv) For e-tendering possession of valid Digital Signature Certificate (Class II or Class III Certificates with signing key usage) is mandatory which can be obtained from SIFY /nCode/eMudra or any Certifying Authority recognized by CCA India on eToken/ SmartCard.
- (v) Upon enrolment on CPP Portal for e-tendering, the bidders shall register their valid Digital Signature Certificate with their profile.
- (vi) Only one valid DSC should be registered by a bidder. Bidders are responsible to ensure that they do not lend their DSCs to others which may lead to misuse and should ensure safety of the same.
- (vii) Bidders can than log into the site through the secured login by entering their userID/ password and the password of the DSC/ eToken.

SEARCHING FOR TENDER DOCUMENTS

- 1) There are various search options built in the CPP Portal to facilitate bidders to search active tenders by several parameters. These parameters could include Tender ID, organization name, location, date, value, etc. There is also an option of advanced search for tenders, wherein the bidders may combine a number of search parameters such as organization name, form of contract, location, date, other keywords, etc., to search for a tender published on the CPP Portal.
- Once the bidders have selected the tenders they are interested in, they may download the required documents / tender schedules. These tenders can be moved to the respective 'My Tenders' folder. This would enable the CPP Portal to intimate the bidders through SMS / e-mail in case there is any corrigendum issued to the tender document.
- 3) The bidder should make a note of the unique Tender ID assigned to each tender, in case they want to obtain any clarification / help from the Helpdesk.

PREPARATION OF BIDS:

(i) For preparation of bid Bidders shall search the tender from published tender list available on site and download the complete tender document and should take into account corrigendum if any published before submitting their bids.

- After selecting the tender document same shall be moved to the 'My favourite' folder of bidders account from where bidder can view all the details of the tender document.
- (ii) Bidder shall go through the tender document carefully to understand the documents required to be submitted as part of the bid. Bidders shall note the number of covers in which the bid documents have to be submitted, the number of documents including the names and content of each of the document that need to be submitted. Any deviations from these may lead to rejection of the bid.
- (iii) Any pre-bid clarifications if required, then same may be obtained online through the tender site, or through the contact details given in the tender document.
- (iv) Bidders should get ready in advance the bid documents in the required format (PDF/xls/rar/dwf/jpg formats) to be submitted as indicated in the tender document/schedule. Bid documents may be scanned with 100 dpi with black and white option which helps in reducing size of the scanned document.
- (v) Bidders can update well in advance, the documents such as experience certificates, annual report, PAN, EPF & other details etc., under "My Space/ Other Important Document" option, which can be submitted as per tender requirements. This will facilitate the bid submission process faster by reducing upload time of bids.

SUBMISSION OF BIDS:

- (i) Bidder should log into the site well in advance for bid submission so that he/ she upload the bid in time i.e. on or before the bid submission time. Bidder will be responsible for any delay.
- (ii) Bidder should prepare the EMD as per the instructions specified in the NIT/ tender document. The details of the DD/BC/BG/ others physically sent, should tally with the details available in the scanned copy and the data entered during bid submission time. Otherwise the uploaded bid will be rejected.
- (iii) While submitting the bids online, the bidder shall read the terms & conditions (of CPP portal) and accepts the same in order to proceed further to submit their bid.
- (iv) Bidders shall select the payment option as offline to pay the EMD and enter details of the DD/BC/BG/others.
- (v) Bidder shall digitally sign and upload the required bid documents one by one as indicated in the tender document.
- (vi) Bidders shall note that the very act of using DSC for downloading the tender document and uploading their offers is deemed to be a confirmation that they have read all sections and pages of the tender document without any exception and have understood the complete tender document and are clear about the requirements of the tender document.
- (vii) Bid documents may be scanned with 100 dpi with black and white option which helps in reducing size of the scanned document. For the file size of less than 1 MB, the transaction uploading time will be very fast.
- (viii) If price quotes are required in XLS format, utmost care shall be taken for uploading Schedule of quantities & Prices and any change/ modification of the price schedule shall render it unfit for bidding.
 - Bidders shall download the Schedule of Quantities & Prices i.e. Schedule-A, in XLS format and save it without changing the name of the file. Bidder shall quote their rate in figures in the appropriate cells, thereafter save and upload the file in financial bid cover (Price bid) only.
 - If the template of Schedule of Quantities & Prices file is found to be modified/corrupted in

- the eventuality by the bidder, the bid will be rejected and further dealt as per provision of clause no 23.0 of ITB including forfeiture of EMD.
- The bidders are cautioned that uploading of financial bid elsewhere i.e. other than in cover 2 will result in rejection of the tender.
- (ix) Bidders shall submit their bids through online e-tendering system to the Tender Inviting Authority (TIA) well before the bid submission end date & time (as per Server System Clock). The TIA will not be held responsible for any sort of delay or the difficulties faced during the submission of bids online by the bidders at the eleventh hour.
- (x) After the bid submission (i.e. after Clicking "Freeze Bid Submission" in the portal), the bidders shall take print out of system generated acknowledgement number and keep it as a record of evidence for online submission of bid, which will also act as an entry pass to participate in the bid opening.
- (xi) Bidders should follow the server time being displayed on bidder's dashboard at the top of the tender site, which shall be considered valid for all actions of requesting, bid submission, bid opening etc., in the e-tender system.
- (xii) All the documents being submitted by the bidders would be encrypted using PKI (Public Key Infrastructure) encryption techniques to ensure the secrecy of the data. The data entered cannot be viewed by unauthorized persons until the time of bid opening. The confidentiality of the bids is maintained using the secured Socket Layer 128 bit encryption technology.

ASSISTANCE TO BIDDERS:

- (i) Any queries relating to the tender document and the terms and conditions contained therein should be addressed to the Tender Inviting Authority for a tender or the relevant contract person indicated in the tender. The contact number for the helpdesk is 0512-259-7948 between 10:30 hrs to 17:00 hrs.
- (ii) Any queries relating to the process of online bid submission or queries relating to CPP Portal in general may be directed to the 24X7 CPP Portal Helpdesk. The 24 x 7 Help Desk Number 0120-4200462, 0120-4001002 and 0120-4001005. The helpdesk email id is support-eproc@nic.in

INSTRUCTION FOR e-PROCUREMENT

1. PREPARATION AND SUBMISSION OF BIDS:

- a. The detailed tender documents may be downloaded fromhttp://eprocure.gov.in/eprocure/app till the last date of submission of The Tender online tender. may be submitted through **CPP** Portal http://eprocure.gov.in/eprocure/app
- b. The bidder should submit the bid online in two parts viz. Technical Bid and Financial Bid. Technical Bid should be upload online in cover 1 and Financial Bid in ".Xls" should be upload online in cover-2
- 2. <u>SUBMISSION OF THE BID</u>: All interested eligible bidders are requested to submit their bids online on CPP Portal: http://eprocure.gov.in/eprocure/app per the criteria given in this document:
 - **a.** Technical Bid should be upload online in cover-1.
 - **b.** Financial Bid should be upload online in cover-2

Both Technical and Financial Bid covers should be placed online on the CPP Portal (http://eprocure.gov.in/eprocure/app).

3. <u>TECHNICAL BID</u>: Signed and Scanned copies of the Technical bid documents as under must be submitted online on CPP Portal: http://eprocure.gov.in/eprocure/app.

List of Documents to be scanned and uploaded (Under Cover-1) within the period of bid submission:-

- i. Scanned copy of Bank details.
- ii. Scanned copy of work experience.
- iii. Scanned copy of certificate of GST.
- iv. Scan copy of tender acceptance letter.
- v. Scanned copy of specifications or brochures (if any).
- vi. Scanned copy of other document mentioned in tender document (if any)

Please note that no indication of the rates/amounts be made in any of the documents submitted with the TC-BID.

4. Financial Bid

- **a.** The currency of all quoted rates shall be Indian Rupees/USD.
- **b.** In preparing the financial bids, bidders are expected to take into account the requirements and conditions laid down in this Tender document. The financial

bids should be uploaded online as per the specified ".XIs" format i.e. Price Bid Excel sheet attached as '.XIs' with the tender and based on the scope of work, service conditions and other terms of the Tender document. It should include all costs associated with the Terms of Reference/Scope of Work of the assignment.

c. The Financial Proposal should be inclusive of all applicable taxes, duties, fees, levies, and other charges imposed under the applicable laws. The rates quoted in the Tender are inclusive of all applicable taxes, duties etc. except service tax. The service tax component shall be re-immersible by the department after receipt of paid challans etc. if applicable.

5. Last Date for Submission of Tender:

- **a.** Online bids complete in all respects, must be submitted on or before the last date and time specified in the schedule of events.
- **b.** The IIT, Kanpur may, at its own discretion, alter/extend the last date for submission of tenders.

6. Bid Validity

- **a.** All the Bids must be valid for a period of 180 days from the last date of submission of the tender for execution of Contract. However, the quoted rates should be valid for the initial/extended period of the Contract from the effective date of the Contract. No request will be considered for price revision during the original Contract period.
- **b.** A bid valid for a shorter period shall be declared as non-responsive.
- c. In exceptional circumstances, prior to expiry of the original time limit, the IIT may request the bidders to extend the period of validity for a specified additional period beyond the original validity of 180 days. The request and the bidders' responses shall be made in writing. The bidders, not agreeing for such extensions will be allowed to withdraw their bids without forfeiture of their Bid Security.

7. Modification / Substitution / Withdrawal of bids:

- **a.** No Bid shall be modified, substituted or withdrawn by the Bidder after the Bid 's due Date.
- **b.** Any alteration/ modification in the Bid or additional information supplied subsequent to the Bid's due Date, unless the same has been expressly sought for by the Authority, shall be disregarded.
- 8. **Rejection of the Bid**: The bid submitted shall become invalid and tender fee shall not be refunded if:
 - a. The bidder is found ineligible.

b. The bidder does not upload all the documents as stipulated in the bid document.

Tender document

Department of Physics Indian Institute of Technology Kanpur Kanpur (UP) 208016 India

Enquiry date: August 27, 2019

Enquiry No: IITK/PHY/IMPII/2019-20/01

Online quotations: Manual Wedge wire and Ribbon Bonder.

Prof. Satyajit Banerjee Dept. of Physics IIT Kanpur Kanpur -208016, UP, India.

Terms and Conditions:

- All equipment must be compatible with Indian electrical standards and codes. Engineering documentation on the physical sizes and weights of all major and minor components must be submitted.
- 2. Warranty & Support: One comprehensive on-site for Hardware and training support. Extended warranty at no extra cost will be desirable.
- 3. Quotations must be valid for 120 days from the last date of submission of the tender for execution of contract.
- 4. Delivery period will be 12 weeks.
- 5. IIT Kanpur is fully exempted from payment of GST on Imported Goods against our DSIR certificate.
- 6. IIT Kanpur is partially exempted from payment of Customs Duty (We will provide Custom Duty Exemption Certificate, CD applicable is 5.5%).
- 7. The Institute reserves the right of accepting or rejecting any quotations without assigning any reason thereof.
- 8. All prices should be *F.O.B.*

Specifications of the Manual wedge wire and ribbon Bonder:

Sl.no	Item	Description		
1	Bonding Method	Wedge & Ribbon Bonding		
2	Bonding Process	Thermosonic process.		
3	Controlling System			
a.	Control Logic	Analog dials		
b.				
4	Ultrasonic System	Built in, PLL based, Self tuning between 60-65KHz		
a.	Ultrasonic Power	Programmable, 0-2W		
5	Work holder temperature	Ambient to $250^{\circ}\text{C} \pm 5^{\circ}\text{C}$		
7	Bondable wires and Ribbon			
a.	Wire/Ribbon Material	Gold and Aluminium		
b.	Wire Size	1 mil		
c.	Ribbon size	Up to 1 x 10mil		
8	Wire spool holder	Inbuilt wire spool holder for 2 inch as well as ½ inch spool		
9	Bonding Parameters			
a.	Bond force range	15 to 150 gm		
b.	Bond time range	10 to 400mSec		
0.	Dona time range	To to roomsee		
10	Bonding tool			
a.	Wedge bond tool for 1 mil Au & Al	Tool length 0.750 inch: 02 Nos. each.		
	wire			
11	Bond head movement			
a.	XY positioning	By Manipulator 4:1, Manual		
b.	Motorized movement in Z (vertical	range - 0.5 inch or better		
	access)			
c.	X-Y and Z movement	Independent Z axis movement from X-Y movement		
d	Long horizontal reach	3.5 inches or better		
d.	Motorized verticalwire feeding	Required		
e.	Wire termination method	clamp tear and table tear		
f.	Deep vertical access	0.59in or better		
g.	Adjustable tear	Required		

h.	Adjustable tail length by 1 mil resolution	Required
12	Bonder Optics and Vision System	
	Microscope	Stereo zoom with 15X eyepiece or better, total optical magnification 10X-75X or better White LED illuminator
13	Work holder	
a.	Adjustable Height Heated Work holder with mechanical and vacuum Clamping	Top surface diameter: 2 inches or better; Temperature control range: Ambient to 250°C. Substrate size: 0.5in x 0.5in to 1.0in x 1.0in.
14	Bonding wire	
a.	Aluminium wire	½" spool of wire with 99% purity (1% Si).
	1 mil wire	02Nos.
b.	Gold Wire	2" spool of wire (app. 375 ft) with 99.99% purity.
	1 mil wire	1Nos.
15	Wire Clamp	Swing Away Wire/Ribbon Clamps
15	Ability to do bonding of wires on relatively soft sample surfaces like GaAs and InGaAs, and Graphene substrates, causing minimal indentation and damage. There should be specification in your model which should be able to handle this.	Please specify any specific features of your bonding machine which will enable doing bonding of soft surfaces and substrates. Such that the bonding will cause minimum damage to the tool as well as to the bonding surface without creating much indentation on the surface. If the technology is proprietary, please mention it and accompany your specifications with a Proprietary certificate from the principals.
	Ability to do bonding of wires on relatively soft sample surfaces like GaAs and InGaAs, and Graphene substrates, causing minimal indentation and damage. There should be specification in your model which should be able to	Please specify any specific features of your bonding machine which will enable doing bonding of soft surfaces and substrates. Such that the bonding will cause minimum damage to the tool as well as to the bonding surface without creating much indentation on the surface. If the technology is proprietary, please mention it and accompany your specifications with a Proprietary certificate from the
16.	Ability to do bonding of wires on relatively soft sample surfaces like GaAs and InGaAs, and Graphene substrates, causing minimal indentation and damage. There should be specification in your model which should be able to handle this.	Please specify any specific features of your bonding machine which will enable doing bonding of soft surfaces and substrates. Such that the bonding will cause minimum damage to the tool as well as to the bonding surface without creating much indentation on the surface. If the technology is proprietary, please mention it and accompany your specifications with a Proprietary certificate from the principals. If your bonding machine has a proprietary technology, please give details of the technology. Specify how it will be useful. Indicate specifically how it will ensure the bonding machine is better than competing models available in the market. If the technology is proprietary then please include a proprietary certificate in the technical bid. The certificate should be from
16.	Ability to do bonding of wires on relatively soft sample surfaces like GaAs and InGaAs, and Graphene substrates, causing minimal indentation and damage. There should be specification in your model which should be able to handle this. Proprietary technology	Please specify any specific features of your bonding machine which will enable doing bonding of soft surfaces and substrates. Such that the bonding will cause minimum damage to the tool as well as to the bonding surface without creating much indentation on the surface. If the technology is proprietary, please mention it and accompany your specifications with a Proprietary certificate from the principals. If your bonding machine has a proprietary technology, please give details of the technology. Specify how it will be useful. Indicate specifically how it will ensure the bonding machine is better than competing models available in the market. If the technology is proprietary then please include a proprietary certificate in the technical bid. The certificate should be from the principals

a.	One hard copy of Operating and Maintenance Manual having Electrical/Electronic Circuits diagrams	
b.	One soft copy of Operating and Maintenance Manual having Electrical/Electronic Circuits diagrams	
20	Warranty	Standard Warranty should be provided for 1 year. Any extended warranty at no extra cost will be desirable.
21	Training	Training should be provided by Supplier on user site for at least two days about basic routine maintenance and repair.
22	Installation and commissioning	Installation and commissioning at User's site free of cost. Installation data like machine size, machine weight, floor space required, total electrical load and other specific requirement should be provided by the supplier.
23	Company should have supplied atleast 3 wire bonders to reputed organizations /institutions in India in last 3 to 5 years.	Please give names of Institutions and contact persons details.
22	Acceptance criteria	Tendering party from IIT Kanpur <u>may</u> decide that the company demonstrates wedge-wedge bonding on samples provided by IIT Kanpur using gold and aluminium wire of 1 mil in diameter. Testing should be completed within 1 to 7 days week after opening of technical bid. Do you accept (Yes/No).
23	Company turnover	

The technical bid shouldn't disclose in anyway any financial information. <u>Any disclosure of financial information in the technical bid will lead to immediate disqualification of the bid from the tendering process.</u>

In the technical bid, apart from giving all supporting documents and information and brochure and specs of your proposed model. Please include in a tabular form as shown below a comparison of specifications of your proposed model against the points asked above. For example

ľ	Sl.no	Item	Description	Model xyz, company name
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1	Bonding Method	Wedge & Ribbon Bonding	Wedge only
2	Bonding Process	Thermosonic process.	Only thermal
3	Controlling System		
a.	Control Logic	Analog dials	Digital
b.			
4	Ultrasonic System	Built in, PLL based, Self tuning between 60-65KHz	Built in Phase locked loop with self tuning between 40 -50 kHz
a.	Ultrasonic Power	Programmable, 0-2W	Power between 0 – 1 W
5	Work holder temperature	Ambient to $250^{\circ}\text{C} \pm 5^{\circ}\text{C}$	Ambient to 200 C
••	••		
	•••		

Please include a sheet about the total turnover of your company and details about your company. To give an idea about the standing of your company in the market related to the specific product I am ordering.

The company should give detailed information of the delivery period of the item ordered.

Please note final decision will be based on market presence, stature of the company, after sales service and customer feedback.

Please ensure competitive pricing with discounts in your financial bid for the model recommended in the technical bid. Final decision will be based on technical and financial bid and market reputation and standing.

Appendix

TENDER ACCEPTANCE LETTER (To be given on Company Letter Head)

Date:	
To,	
Sub: Acceptance of Terms & Conditions of Tender.	
Tender Reference No:	
Name of Tender / Work: -	
Dear Sir,	
1. I/ We have downloaded / obtained the tender document(s) for the above mentioned 'Tender/Work' from the web site(s) namely:	n
as per your advertisement, given in the above mentioned website(s).	
2. I / We hereby certify that I / we have read the entire terms and conditions of the tender documents from P No to (including all documents like annexure(s), schedule(s), etc .,), which form part of contract agreement and I / we shall abide hereby by the terms / conditions / clauses contained therein.	
3. The corrigendum(s) issued from time to time by your department/ organisation too have also been taken i consideration, while submitting this acceptance letter.	into
4. I / We hereby unconditionally accept the tender conditions of above mentioned tender document (corrigendum(s) in its totality / entirety.	s) /
5. I / We do hereby declare that our Firm has not been blacklisted/ debarred/ terminated/ banned by any G	ovt.

6.~I / We certify that all information furnished by our Firm is true & correct and in the event that the information is found to be incorrect/untrue or found violated, then your department/organisation shall without

Department/Public sector undertaking.

giving any notice or reason therefore or summarily reject the bid or terminate the contract, without preju	ıdice
to any other rights or remedy including the forfeiture of the full said earnest money deposit absolutely.	

Yours Faithfully, (Signature of the Bidder, with Official Seal)